

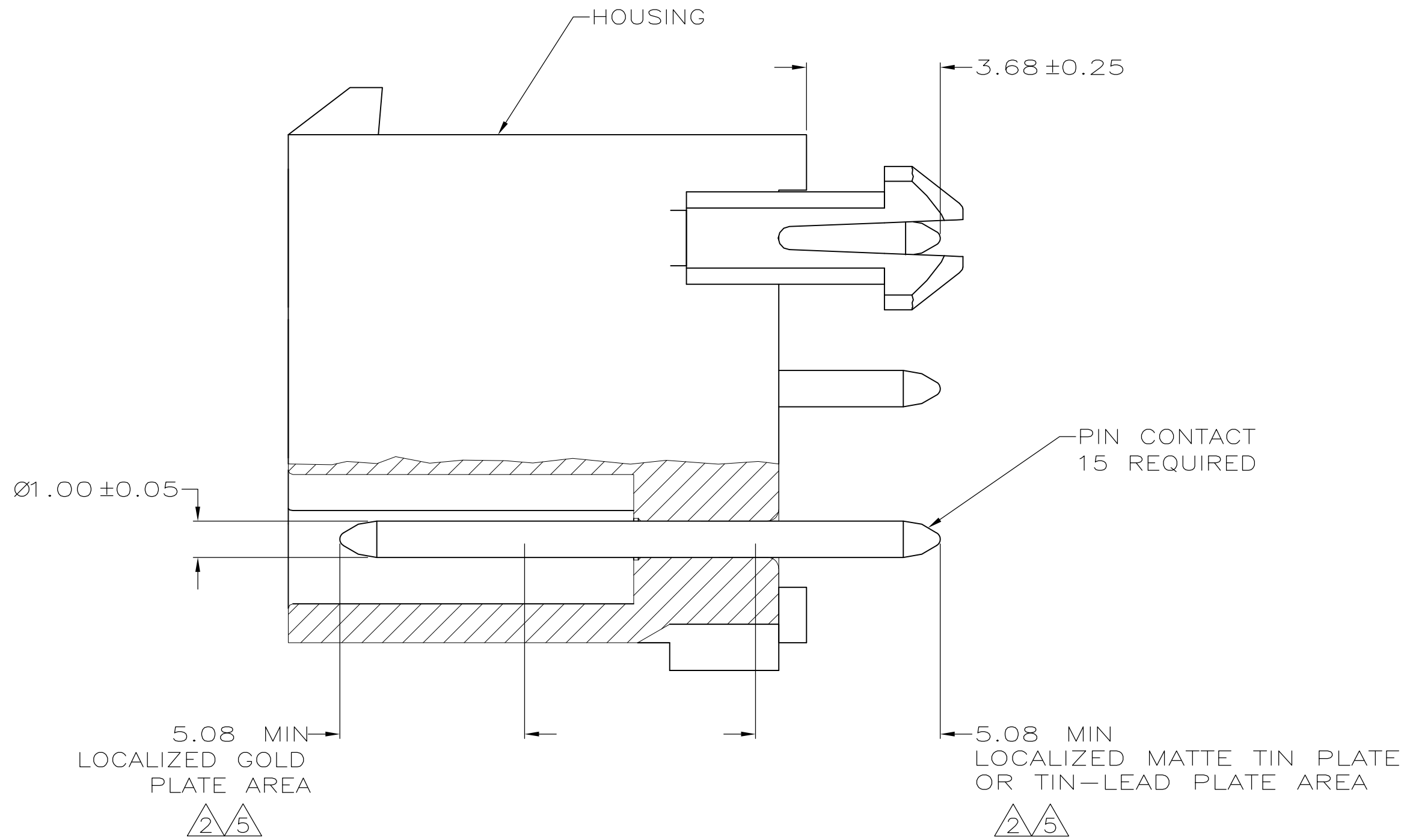
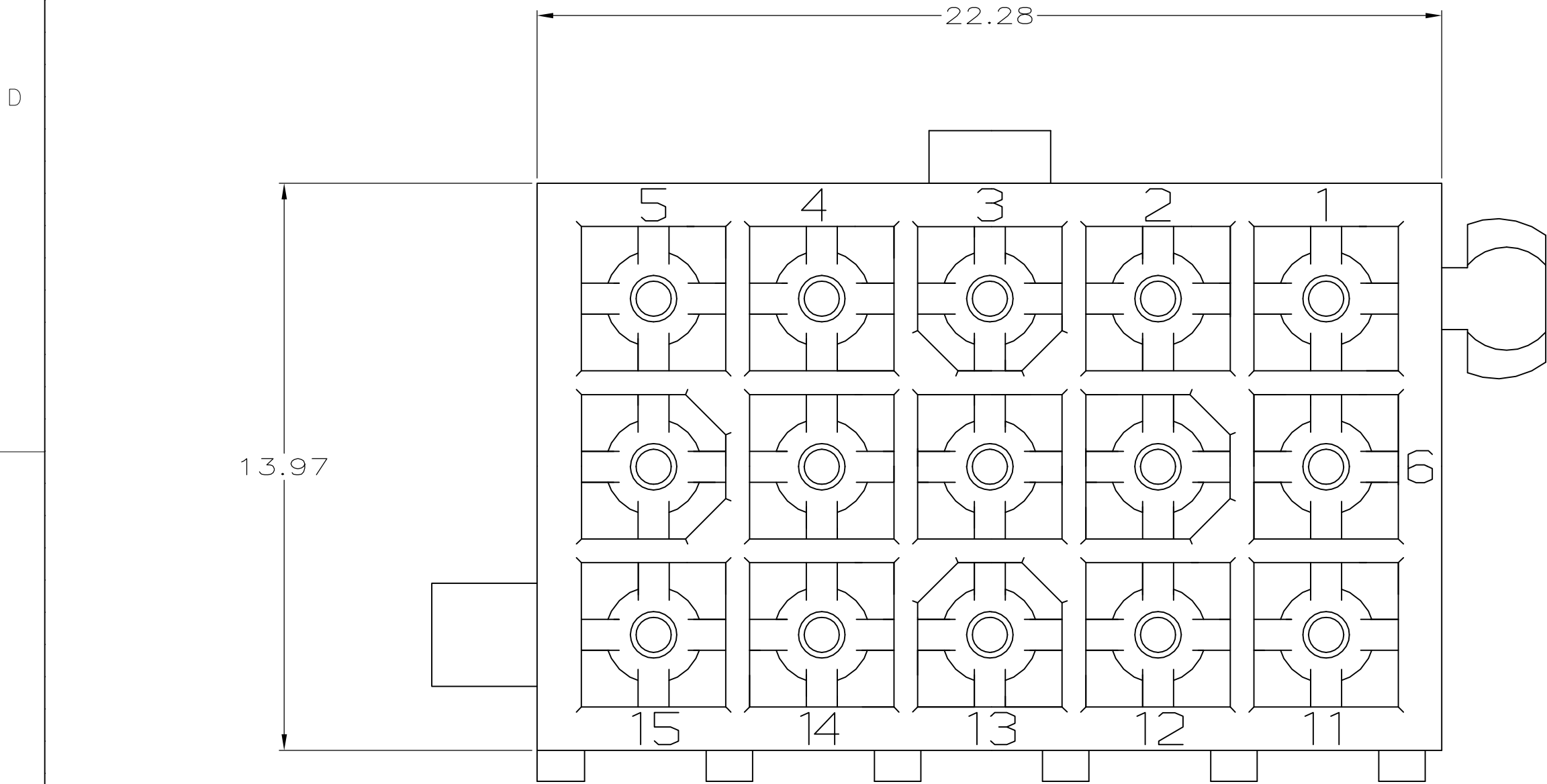
LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
CM	0	J		REVISED PER ECR-15-010337	23JUL2015	RK	SC

D

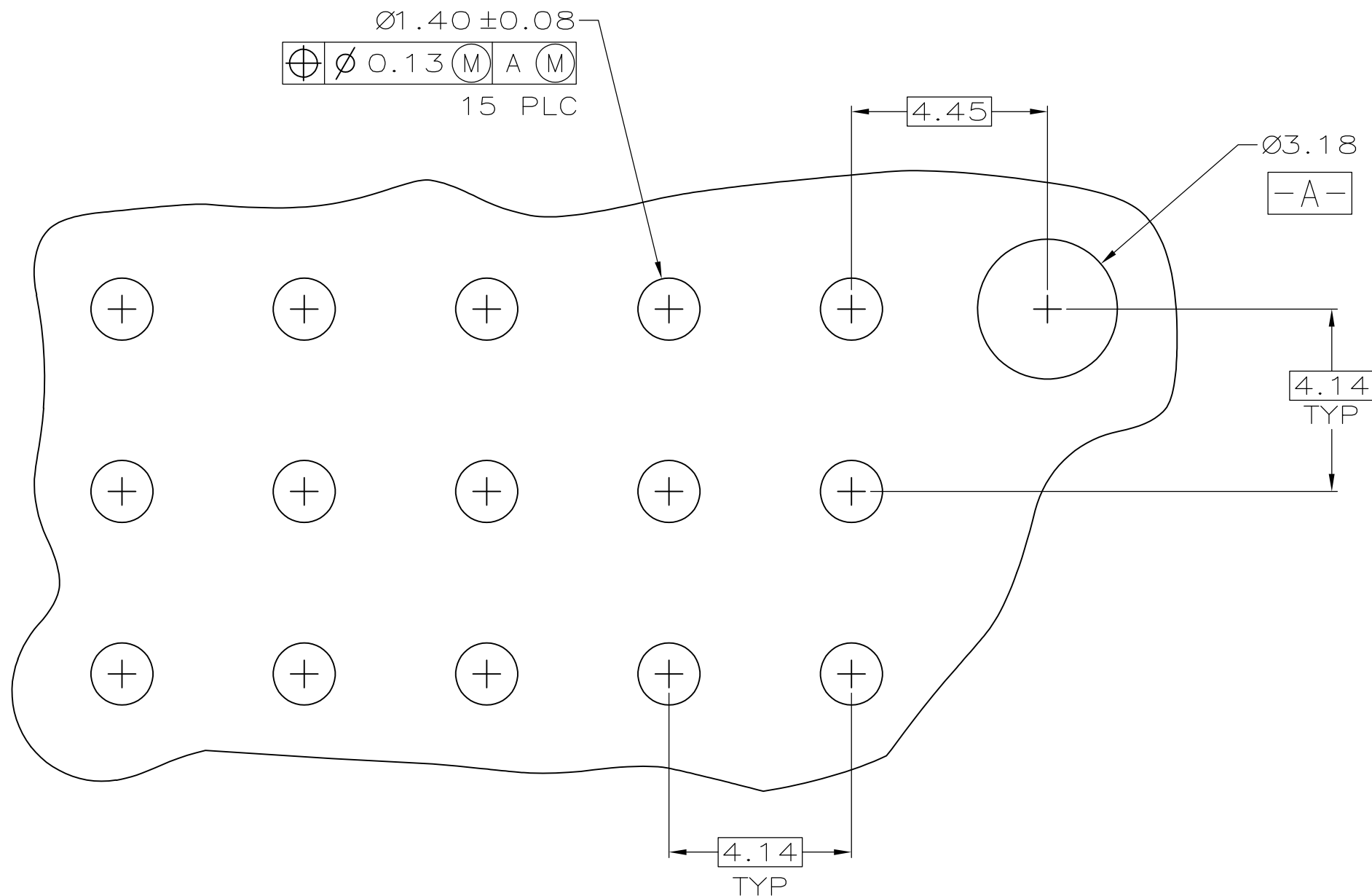
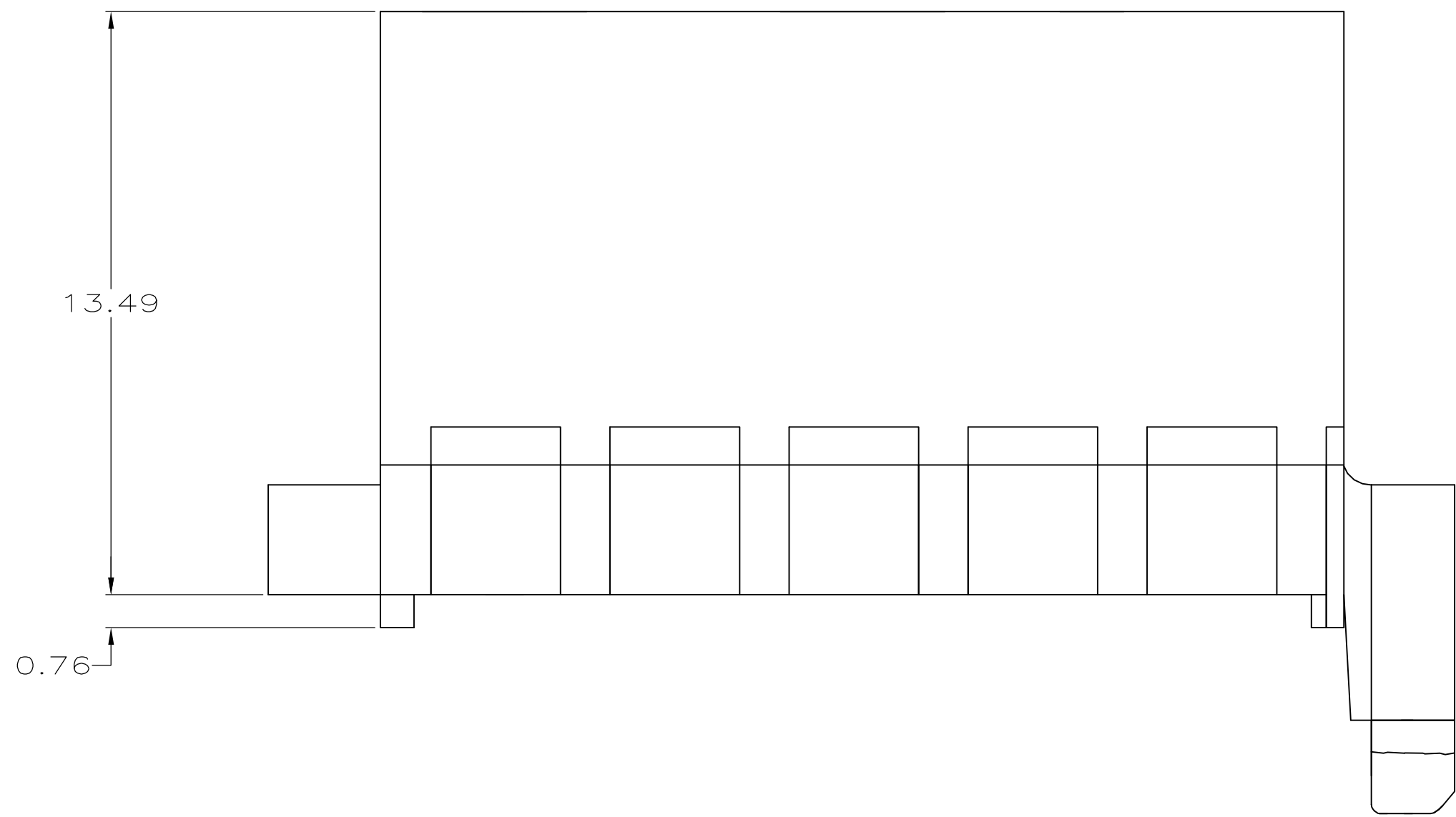
C

B

A



1. PINS TO COMPLY WITH AMP SOLDERABILITY SPEC 109-11-3.
2. 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN LEAD IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.
3. 0.00381 MIN MATTE TIN LEAD OVER 0.00127 MIN NICKEL.
4. 0.00381 MIN MATTE TIN OVER 0.00127 MIN NICKEL.
5. 0.00076 MIN GOLD PLATE IN THE LOCALIZED PLATE AREA, 0.00381 MATTE TIN IN THE LOCALIZED PLATE AREA, BOTH OVER 0.00127 MIN NICKEL.



RECOMMENDED MOUNTING HOLE PATTERN FOR 1.57 THICK P.C. BOARD

BRASS, GOLD	5	NYLON, UL94V-0	WHITE	1-770859-1
BRASS, TIN	4	NYLON, UL94V-0	WHITE	1-770859-0
BRASS, GOLD	2	NYLON, UL94V-0	WHITE	770859-2
BRASS, TIN-LEAD	3	NYLON, UL94V-0	WHITE	770859-1
MATERIAL	FINISH	MATERIAL	COLOR	PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN S CARPENTER	OBJUN05	STE TE Connectivity	
		CHK R JONES	29JUL2003		
DIMENSIONS:		TOLERANCES UNLESS OTHERWISE SPECIFIED:		NAME	
mm		0 PLC ± - 1 PLC ± - 2 PLC ± 0.13 3 PLC ± - 4 PLC ± - ANGLES ± -		PRODUCT SPEC	
MATERIAL		FINISH		APPLICATION SPEC	
-		-		WEIGHT	
				CUSTOMER DRAWING	
				SCALE 8:1	
				SHEET 1 OF 1	
				REV J	